

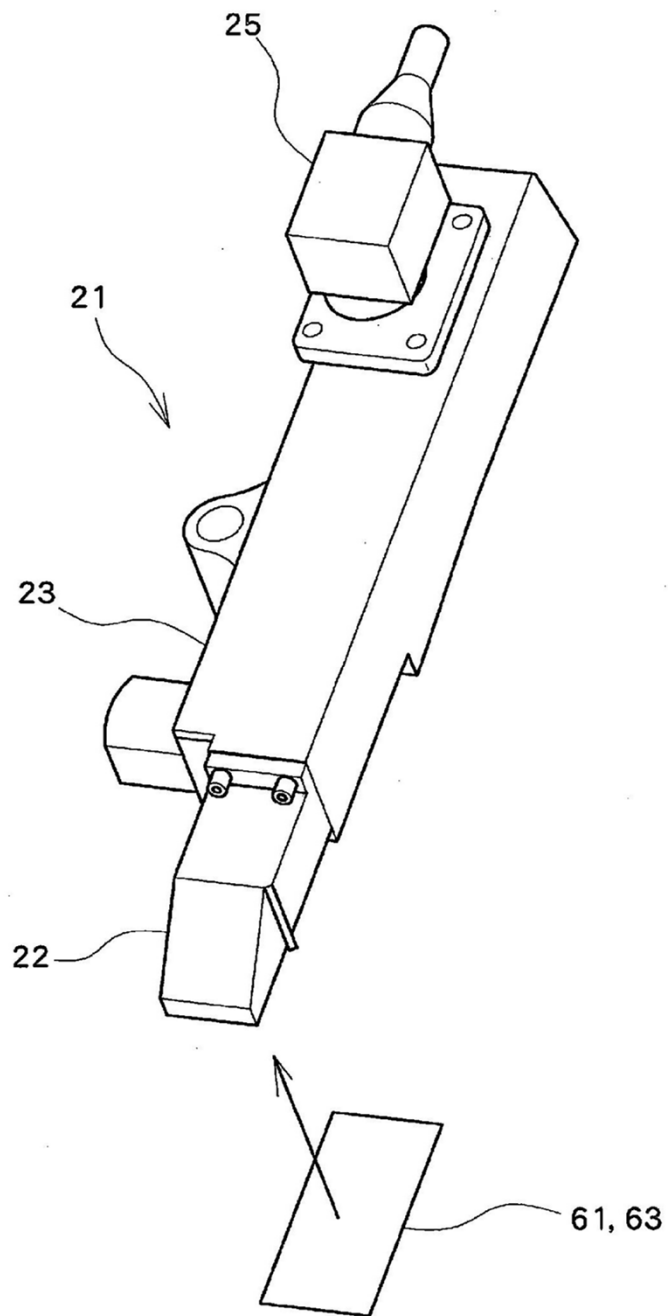


FIG. 2

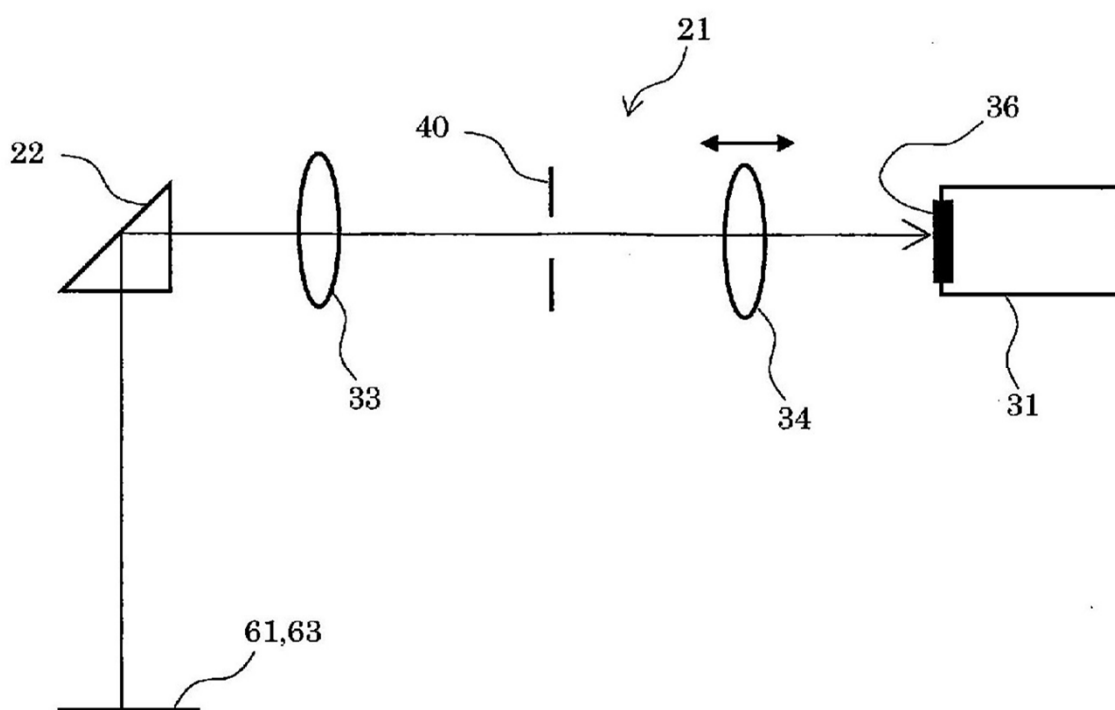


FIG. 3

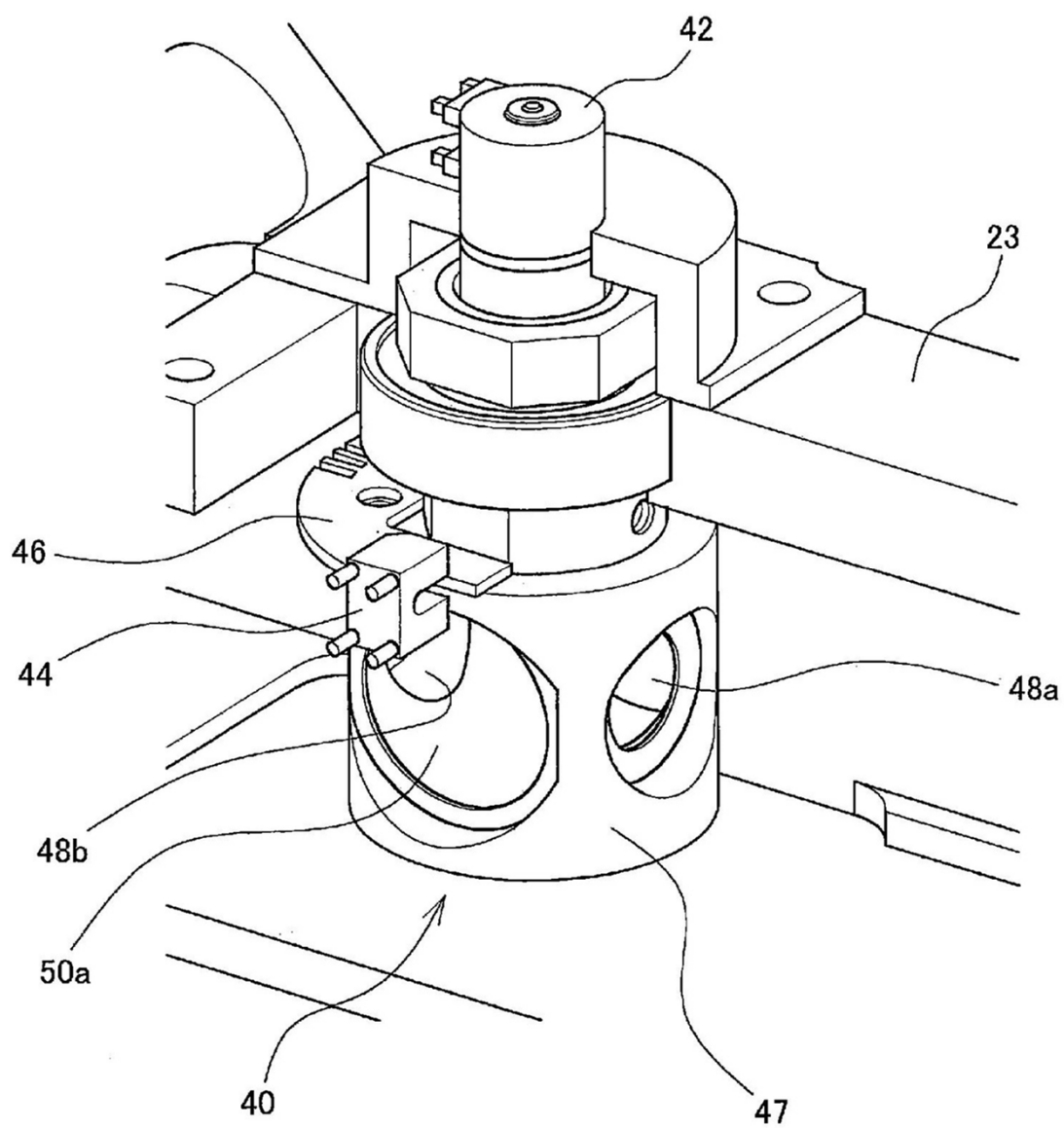


FIG. 4

aperture hole diameter (NA)	optical resolution	depth of field	processes to be performed
small <normal aperture>	low	deep	packaging process (packaging process of laminated device or the like)
Large <high-resolution aperture>	high	shallow	additional processes (adjustment process, measurement process, or the like)

FIG. 5

(A)



(B)



FIG. 6

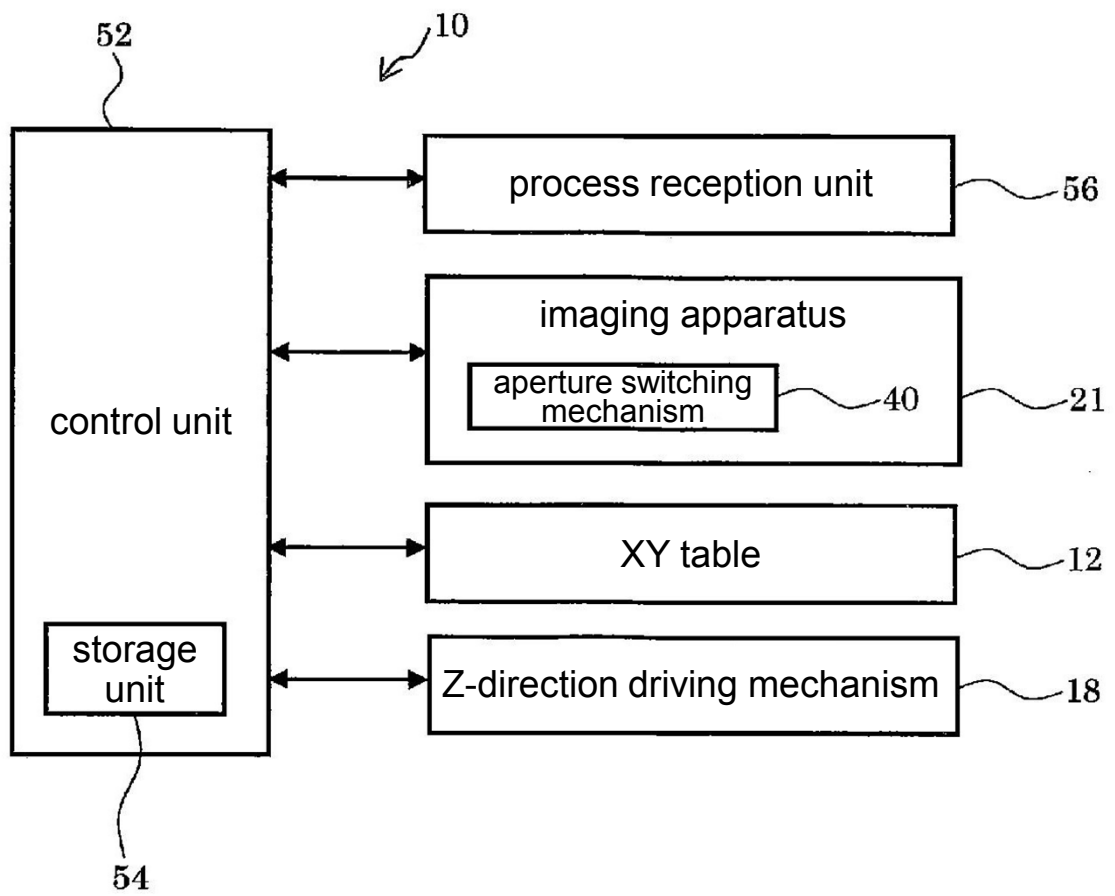


FIG. 7

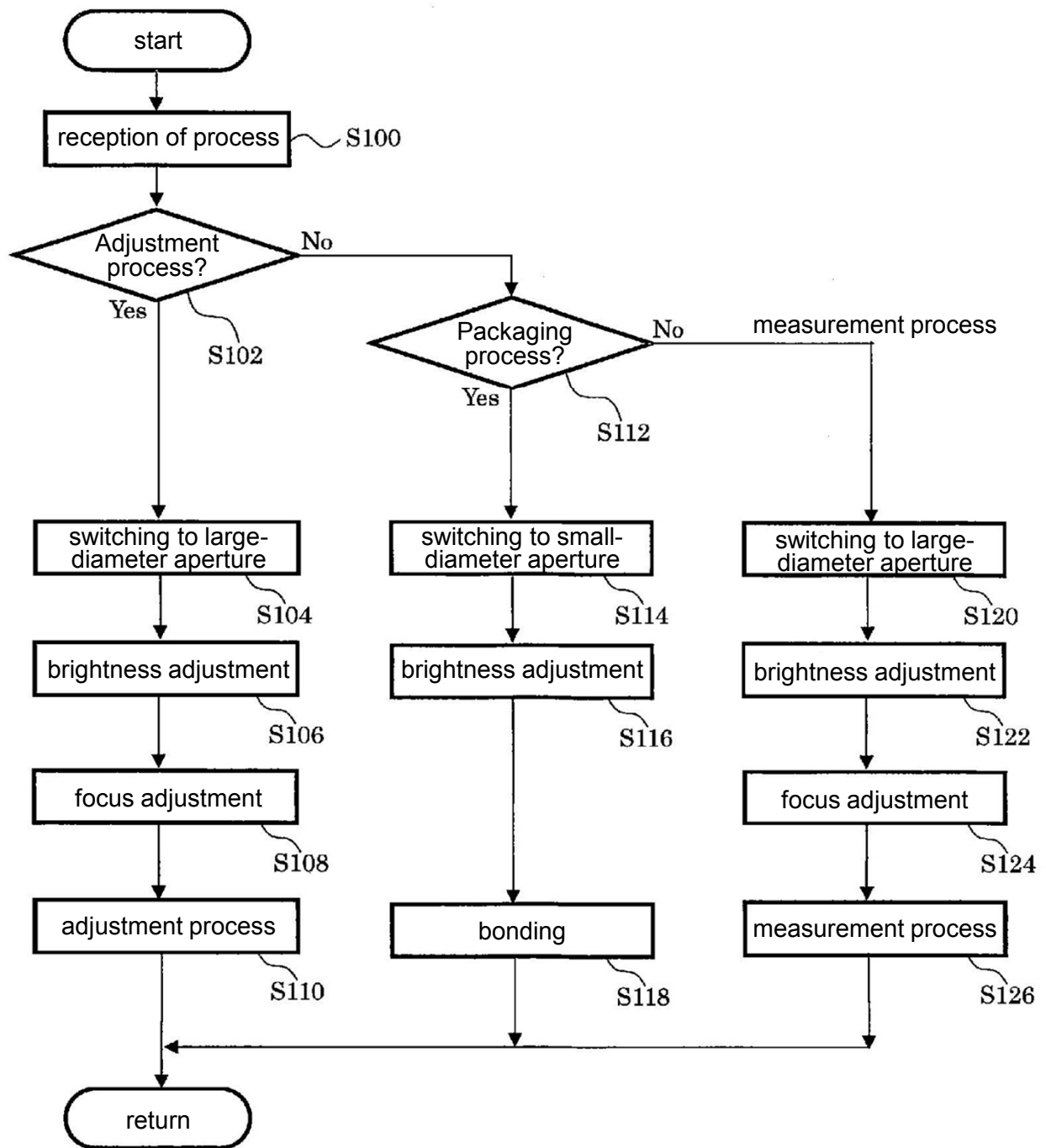


FIG. 8

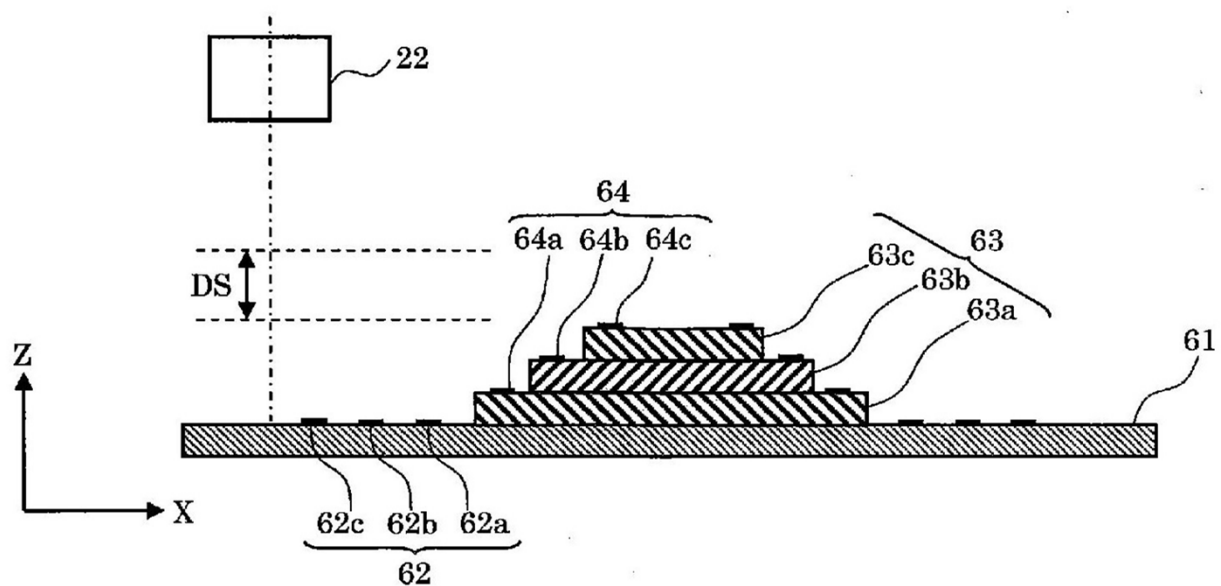


FIG. 9

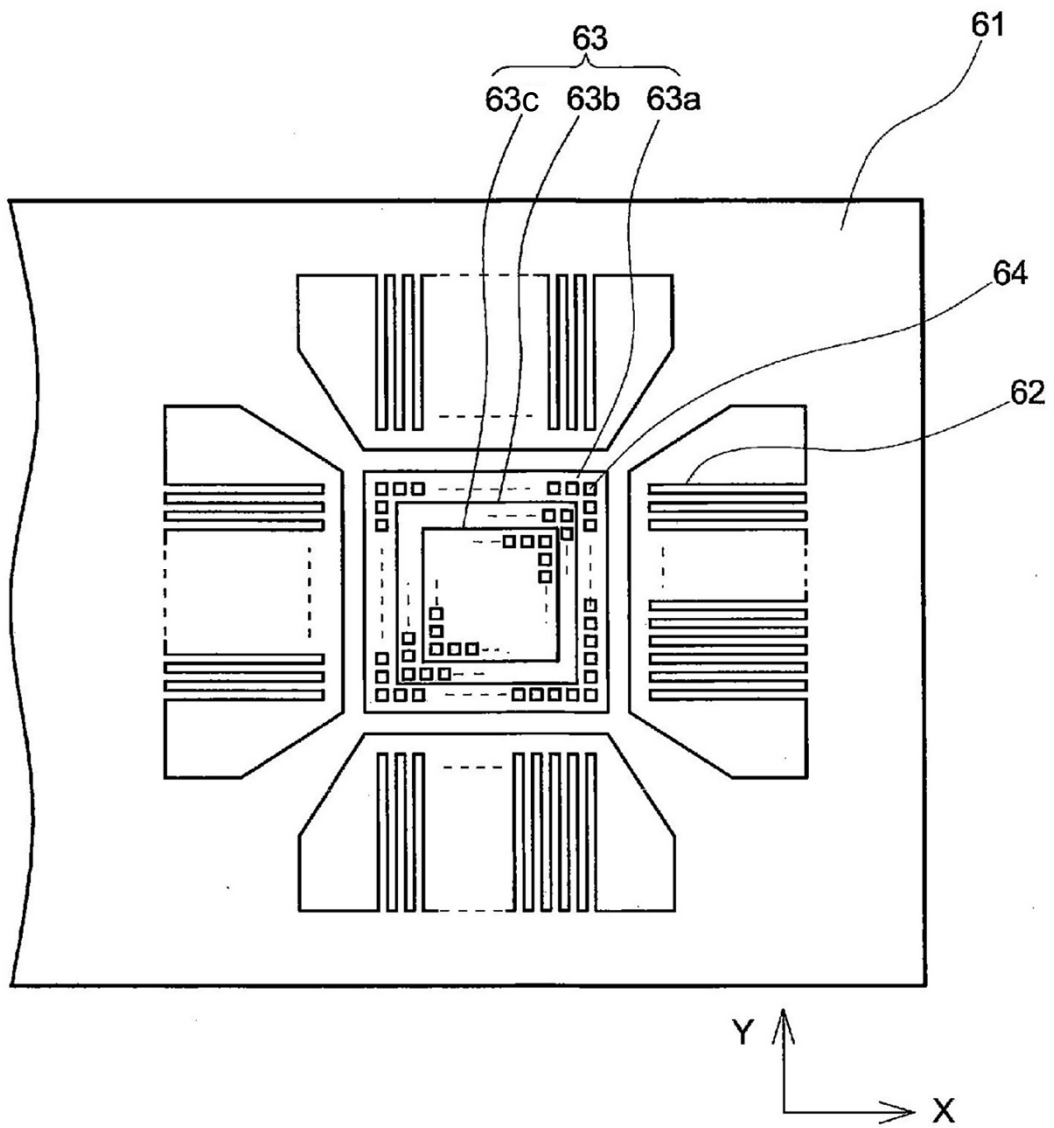


FIG. 10

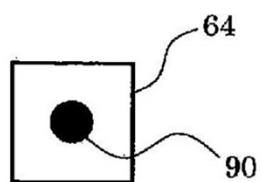


FIG. 11

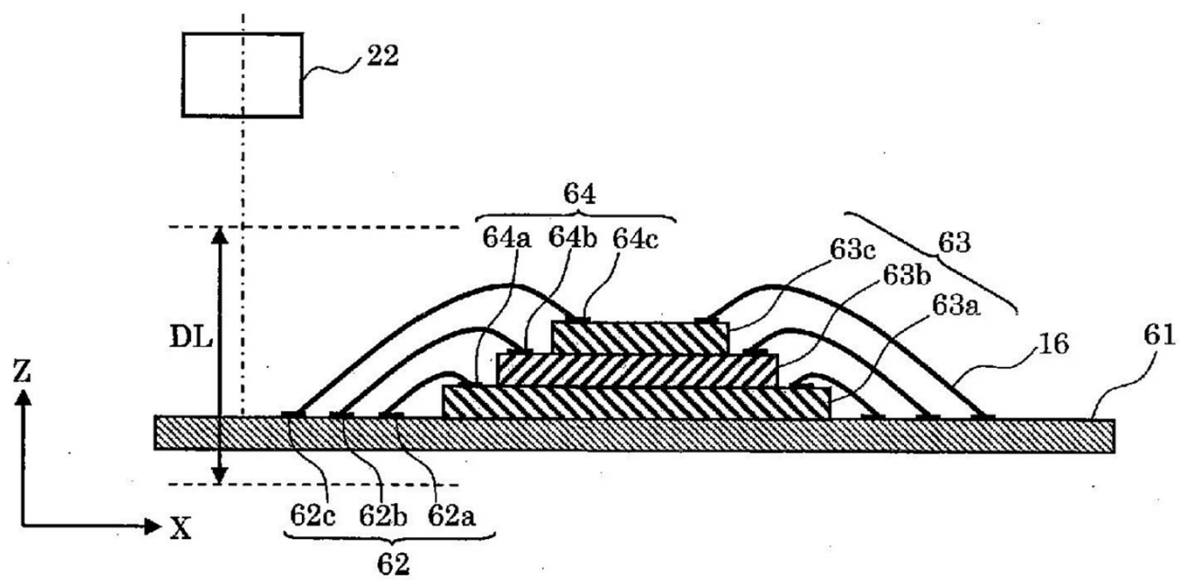


FIG. 12

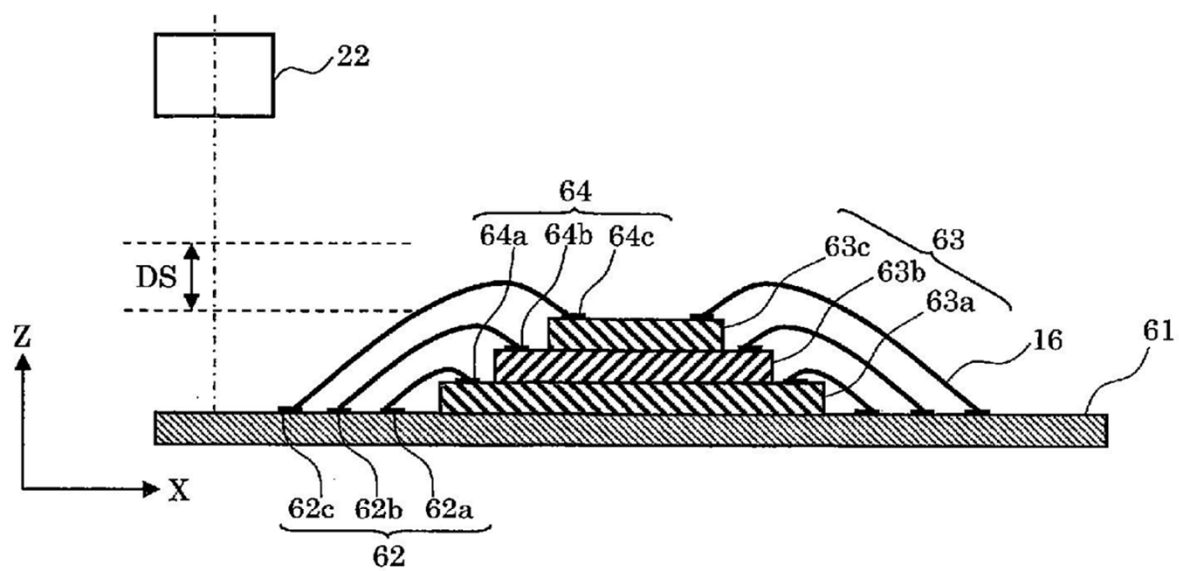


FIG. 13

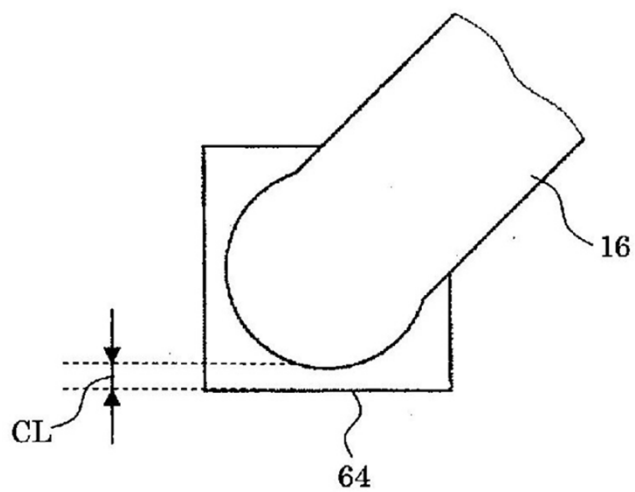


FIG. 14

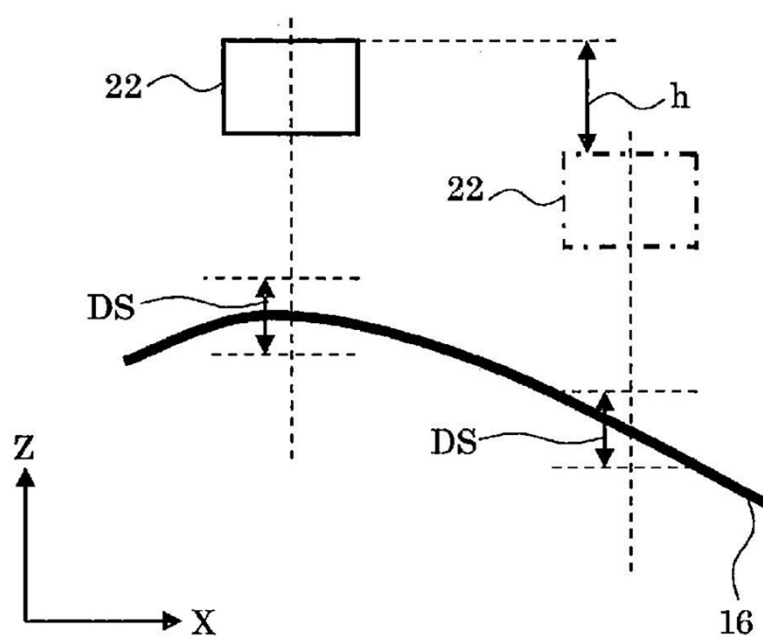


FIG. 15